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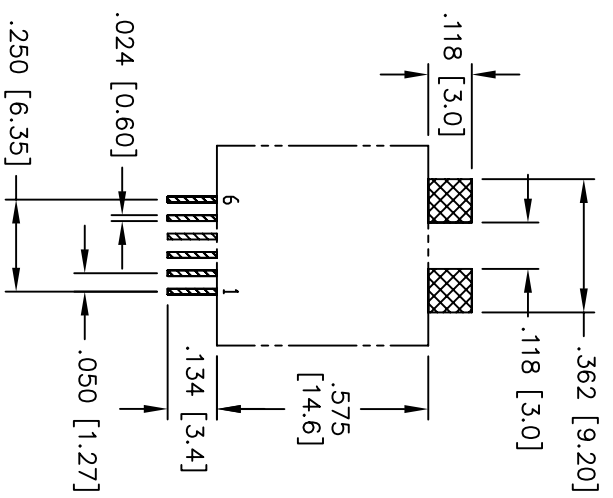
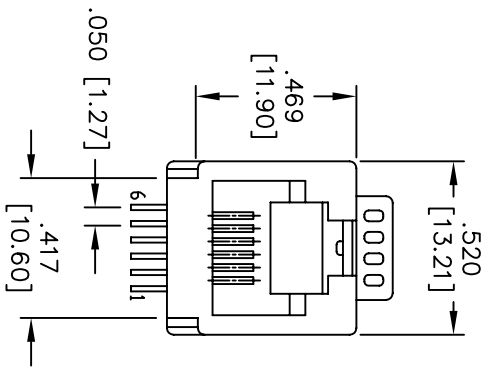
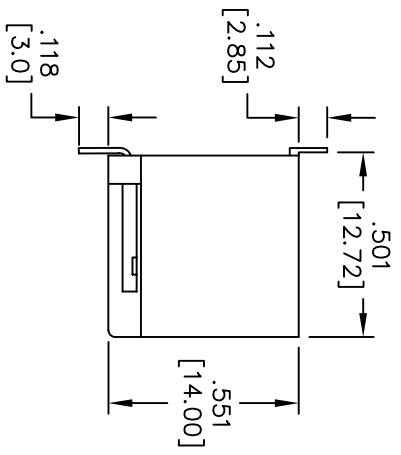
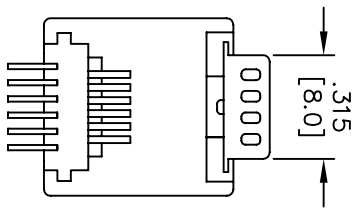
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Rev	AWO #	Description	Date	Appr
-		RELEASED	12/6/07	

APPROVED: _____

DATE: _____ TITLE: _____



PLATING

X	15 μ in Gold
0	30 μ in Gold
1	50 μ in Gold

RECOMMENDED PCB LAYOUT

SPECIFICATIONS:

Material: Insulator: Hi-Temp Nylon46, glass reinforced, rated UL 94V-0

Insulator color: Black

Contacts: .014" [0.35mm] thick Phos-Bronze

Plating: Gold over Nickel underplate on contact area, Tin over Copper underplate on SMT tails. (See chart for thickness)

Electrical:

Operating voltage: 150V AC max

Contact rating: 1.5 Amps max

Contact resistance: 20m ohms max

Insulation resistance: 500 Mohms min

Dielectric withstanding voltage: 1000 VAC for 1 minute

Temperature Rating:

Operating temperature: -40°C to +125°C

Packaging:

Supplied on Tape and Reel

Environmental:

Lead free, RoHS compliant.

Recommended soldering temp: 260°C for 5 sec.



ADAM TECH

909 Railway Avenue, Union, NJ 07083
Phone: 908-687-5000 Fax: 908-687-5710

TITLE: TELEPHONE JACK, SMT, TOP ENTRY,
6P6C, SURFACE MOUNT

UNLESS OTHERWISE SPECIFIED ALL DIMENSIONS ARE MM [INCHES] TOLERANCES: EXCEPT AS NOTED	
.X .XX .XXX .XXX	±.10 ±.020 ±.015 ±.010
ØX ØXX ØXXX	±.10 ±.015 ±.010
APPROVALS	DATE
DRAWN	SHREN
CHECKED	
APPROVED	

SIZE	PART NO.	REV.
X	MTJL66HX1	-
REF:	SCALE: NTS	SHEET 1 OF 1

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